

REMARKS

Claims 1 and 7-11 were examined by the Office, and in the final Office Action of May 28, 2009 all claims are rejected. With this response, claim 1 is amended. All amendments and new claims are fully supported by the specification as originally filed. Support for the amendments can be found at least from page 11, line 15—page 12, line 14. Applicant respectfully requests reconsideration and withdrawal of the objections and rejections in view of the following discussion.

This response is submitted along with a Request for Continued Examination (RCE).

Claim Objections

In section 2, on page 3 of the Office Action, claim 1 is objected to due to informalities. Claim 1 is amended to recite “which is cut off” and “both said insulating layer and said passivation film,” as suggested by the Office in order to correct the informalities. Therefore, applicant respectfully requests withdrawal of the objection to claim 1.

Claim Rejections Under § 103

In section 4, on page 4 of the Office Action, claims 1 and 7-12 are rejected under 35 U.S.C. § 103(a) as unpatentable over Song et al. (U.S. Patent No. 5,851,918) in view of Takizawa et al. (U.S. Patent No. 5,742,074), and in further view of Lee et al. (U.S. Patent No. 6,587,160). Applicant respectfully submits that claim 1 is not disclosed or suggested by the cited references, because the cited references at least fail to disclose or suggest all of the limitations recited in claim 1. Claim 1 is amended to recite that the second metallic line which is formed in the side where the TFT array substrate is cut off and chamfered off. Applicant respectfully submits that at least this limitation is not disclosed or suggested by the cited references.

The Office acknowledges on page 6 of the Office Action that Song fails to disclose that the second metallic line is formed in a side where the TFT array substrate is cut off or chamfered off, and relies upon Lee for this teaching. As mentioned above, claim 1 is amended to recite cut off and chamfered off. Lee only discloses a shorting bar (102) and cutting line (11). However, Lee is silent regarding chamfering at the cutting line (11). Instead, Lee only states that the cutting line (11) is where the substrate (10) is cut to remove the shorting bar (102). See Lee

column 6, lines 28-29. Therefore, for at least this reason, claim 1 is not disclosed or suggested by the cited references.

Claims 7-12 ultimately depend from independent claim 1, and therefore are not disclosed or suggested by the cited references at least in view of their dependencies.

Conclusion

For at least the foregoing reasons, the present application is believed to be in condition for allowance, and such action is earnestly solicited. The undersigned hereby authorizes the Commissioner to charge Deposit Account No. 23-0442 for any fee deficiency required to submit this response.

Respectfully submitted,

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